

Features

- Halogen Free. "Green" Device (Note 1)
- Glass Passivated Chip Junction
- . High Surge Current Capability
- · Low Leakage
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings @ 25°C (Unless Otherwise Specified)

| Damanastan | 0 | Value | | | | | | 11!4 | |
|----------------------------------------------------------------|--------------------|-------|-------|-------|------------------|-------|-------|-------|------|
| Parameter | Symbol | S10AL | S10BL | S10DL | S10GL | S10JL | S10KL | S10ML | Unit |
| Peak Repetitive Reverse Voltage | V_{RRM} | | | | | | | | |
| Working Peak Reverse Voltage | V_{RWM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| DC Blocking Voltage | V_R | | | | | | | | |
| RMS Reverse Voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Forward Current @ T _L =35°C | I _{F(AV)} | 10 | | | | Α | | | |
| Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave | - | | | | 200 | | | | Α |
| Non-Repetitive Peak Surge Current @ 1ms Square Wave | I _{FSM} | 400 | | | | | | | |
| I²t Rating for Fusing @1ms≤t≤8.3ms | I ² t | 166 | | | A ² s | | | | |

Marking Code

| Part Number | Marking Code |
|-------------|--------------|
| S10AL | S10AL |
| S10BL | S10BL |
| S10DL | S10DL |
| S10GL | S10GL |
| S10JL | S10JL |
| S10KL | S10KL |
| S10ML | S10ML |

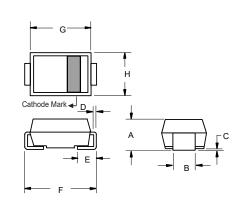
| Marking Diagram | Internal Structure | | |
|---------------------------|--------------------|--|--|
| 1 MCC XXXX 2 Marking Code | 1 ∘——— ∘ 2 | | |

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. High Temperature Solder Exemption Applied, see EU Directive Annex 7a.

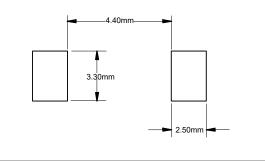
10 Amp Glass Passivated Rectifier 50 to 1000 Volts

SMC (DO-214AB)



| DIMENSIONS | | | | | | | |
|------------|-------|-------|-------------|-------|------|--|--|
| DIM INCHE | | HES | ES MM | | NOTE | | |
| DIIVI | MIN | MAX | MAX MIN MAX | | NOIL | | |
| Α | 0.079 | 0.103 | 2.00 | 2.62 | | | |
| В | 0.108 | 0.128 | 2.75 | 3.25 | | | |
| С | 0.002 | 0.008 | 0.051 | 0.203 | | | |
| D | 0.006 | 0.012 | 0.152 | 0.305 | | | |
| Е | 0.030 | 0.060 | 0.76 | 1.52 | | | |
| F | 0.305 | 0.320 | 7.75 | 8.13 | | | |
| G | 0.260 | 0.280 | 6.60 | 7.11 | | | |
| Н | 0.220 | 0.245 | 5.59 | 6.22 | | | |

Suggested Solder Pad Layout





Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|---------------------------------------------|------------|-----|-----|-----|------|
| T _J | Operating Junction Temperature Range | | -55 | | 150 | °C |
| T _{stg} | Storage Temperature Range | | -55 | | 150 | °C |
| Rth _(J-L) | Thermal Resistance from Junction to Lead | Note 1 | | 12 | | °C/W |
| Rth _(J-A) | Thermal Resistance from Junction to Ambient | Note 1 | | 45 | | °C/W |

Electrical Characteristics @ 25°C Unless Otherwise Specified

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|----------------------|----------------|-------------------------------------------------------------------|-----|------|----------|------|
| Forward Voltage | V _F | I _F =10A;T _J =25°C | | 0.96 | 1.10 | V |
| Reverse Current | I _R | at Rated $V_R;T_J=25^{\circ}C$ at Rated $V_R;T_J=100^{\circ}C$ | | | 5 100 | μА |
| Junction Capacitance | CJ | V _R =4V;f=1MHz;T _J =25°C | | 55 | | pF |



Curve Characteristics

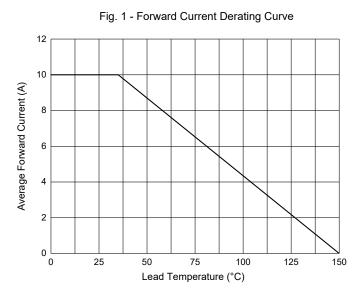


Fig. 3 - Typical Forward Characteristics

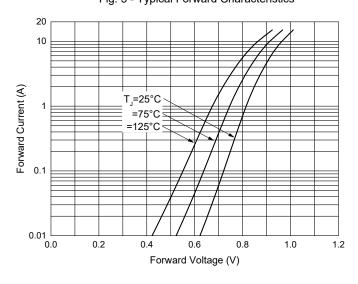


Fig. 5 - Typical Capacitance Characteristics

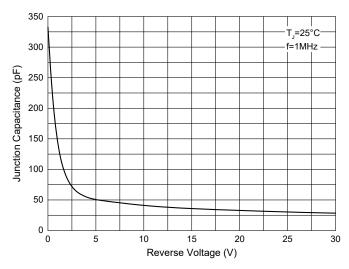


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge
Current

240

200

80

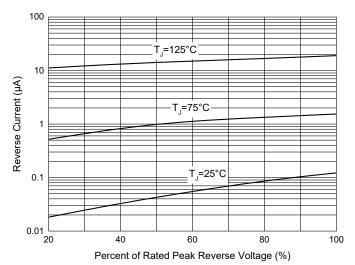
80

80

8.3 ms Single Half Sine-Wave

Number of Cycles at 60 Hz

Fig. 4 - Typical Reverse Leakage Characteristics





Ordering Information

| Device | Packing | | |
|----------------|----------------------|--|--|
| Part Number-TP | Tape&Reel:3Kpcs/Reel | | |

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